



SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL10C271JB8NNNC
- Description : CAP, 270pF, 50V, ±5%, C0G, 0603

A. Samsung Part Number

			<u>) 10</u>	C 271 ③ ④	<u>J</u> (5)	<u>B</u> 6	<u>8</u> ⑦	<u>N</u> ®	<u>N</u> 9	<u>N</u> 10	<u>C</u> 1	
1	Series	Samsung Mu	lti-layer C	eramic Capa	acito	r						
2	Size	0603 (inc	ch code)	L:	1.6	5 ± 0.1	I	mm		W:	0.8 ± 0.1	mm
3	Dielectric	C0G			8	Inner	elec	ctrod	е		Ni	
4	Capacitance	270 pF				Term	inati	ion			Cu	
5	Capacitance	±5 %				Platin	ng			:	Sn 100%	(Pb Free)
	tolerance				9	Produ	uct				Normal	
6	Rated Voltage	50 V			10	Speci	ial				Reserved for	future use
\bigcirc	Thickness	0.8 ± 0	.1 mm		1	Packa	agin	g			Cardboard T	ype, 7" reel

B. Samsung Reliablility Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	1₩±10% 0.5~5Vrms
Q	1000 min	
Insulation	10,000Mohm or 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.
Resistance	Whichever is Smaller	
Appearance	No abnormal exterior appearance	Microscope (×10)
Withstanding	No dielectric breakdown or	300% of the rated voltage
Voltage	mechanical breakdown	
Temperature	C0G	
Characterisitcs	(From -55 $^\circ\!\!\mathbb{C}$ to 125 $^\circ\!\!\mathbb{C}$, Capacitance change s	shoud be within ±30PPM/℃)
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.
of Termination	terminal electrode	
Bending Strength	Capacitance change :	Bending to the limit (1mm)
	within $\pm 5\%$ or ± 0.5 pF whichever is larger	with 1.0mm/sec.
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder
	is to be soldered newly	245±5℃, 3±0.3sec.
		(preheating : 80~120℃ for 10~30sec.)
Resistance to	Capacitance change :	Solder pot : 270±5℃, 10±1sec.
Soldering heat	within ±2.5% or ±0.25pF whichever is larger	
	Tan δ, IR : initial spec.	

	Performance	Test condition			
Vibration Test	Capacitance change :	Amplitude : 1.5mm			
	within $\pm 2.5\%$ or $\pm 0.25_{pF}$ whichever is larger	From 10Hz to 55Hz (return : 1min.)			
	Tan δ, IR : initial spec.	2hours \times 3 direction (x, y, z)			
Moisture	Capacitance change :	With rated voltage			
Resistance	within $\pm 7.5\%$ or ± 0.75 pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs			
	Q : 200 min				
	IR : 500Mohm or 25Mohm $\cdot \mu F$				
	Whichever is Smaller				
High Temperature	Capacitance change :	With 200% of the rated voltage			
Resistance	within $\pm 3\%$ or ± 0.3 pF whichever is larger	Max. operating temperature			
	Q : 350 min	1000+48/-0hrs			
	IR : 1000Mohm or 50Mohm $\cdot \mu F$				
	Whichever is Smaller				
Temperature	Capacitance change :	1 cycle condition			
Cycling	within $\pm 2.5\%$ or ± 0.25 pF whichever is larger	Min. operating temperature \rightarrow 25 °C			
	Tan δ, IR : initial spec.	\rightarrow Max. operating temperature \rightarrow 25 °C			
		5 cycle test			

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max)

* For the more detail Specification, Please refer to the Samsung MLCC catalogue.



Multi Layer Ceramic Capacitor (MLCC)



1. Model : CL10C271JB8NNNC

2. Description

3. Frequency characteristics

Part no.	CL10C271JB8NNNC			
Size (inch / mm)	0603/1608			
Thickness (mm)	0.8			
Temperature charateristics	C0G			
Capacitance	270 pF			
Capacitance tolerance (%)	± 5 %			
Voltage (V)	50			

